

IRL530STRR-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	R _{DS(on)} (Ω)	I _D (A)
100	0.100 at V _{GS} = 10 V	20

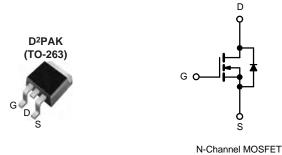
FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

APPLICATIONS

• Isolated DC/DC Converters





ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter	-	Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	I_	20	
Continuous Drain Current $(1) = 175$ C)	T _C = 125 °C	– I _D –	16	A
Pulsed Drain Current		I _{DM}	70	- A
Avalanche Current	L = 0.1 mH	I _{AS}	20	
Single Pulse Avalanche Energy ^b		E _{AS}	200	mJ
Mariana Diasianti d	T _C = 25 °C	P	105	10/
Maximum Power Dissipation ^b	T _A = 25 °C ^d	– P _D –	3.75	- W
Operating Junction and Storage Temperature Rat	nge	T _J , T _{stq}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV		

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25 °$	C, unless o	therwise noted				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		-				
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250	I
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А
		V _{GS} = 10 V, I _D = 20 A		0.100		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.110		Ω
		V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S
Dynamic ^b						
Input Capacitance	C _{iss}			950		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		280		
Reverse Transfer Capacitance	C _{rss}			110		
Total Gate Charge ^c	Qg				28	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 65 A			4.8	nC
Gate-Drain Charge ^c	Q _{gd}				15	
Gate Resistance	R _g		0.5	1.7	3.3	Ω
Turn-On Delay Time ^c	t _{d(on)}			8		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		120		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 65 A, V_GEN = 10 V, R_g = 2.5 Ω		25		ns
Fall Time ^c	t _f			50		
Source-Drain Diode Ratings and Cha	aracteristics 7	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$				
Continuous Current	۱ _S				65	٨
Pulsed Current	I _{SM}			1	140	A
Forward Voltage ^a	V _{SD}	$I_{F} = 65 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V
Reverse Recovery Time	t _{rr}			130	200	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/µs		8	12	А
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

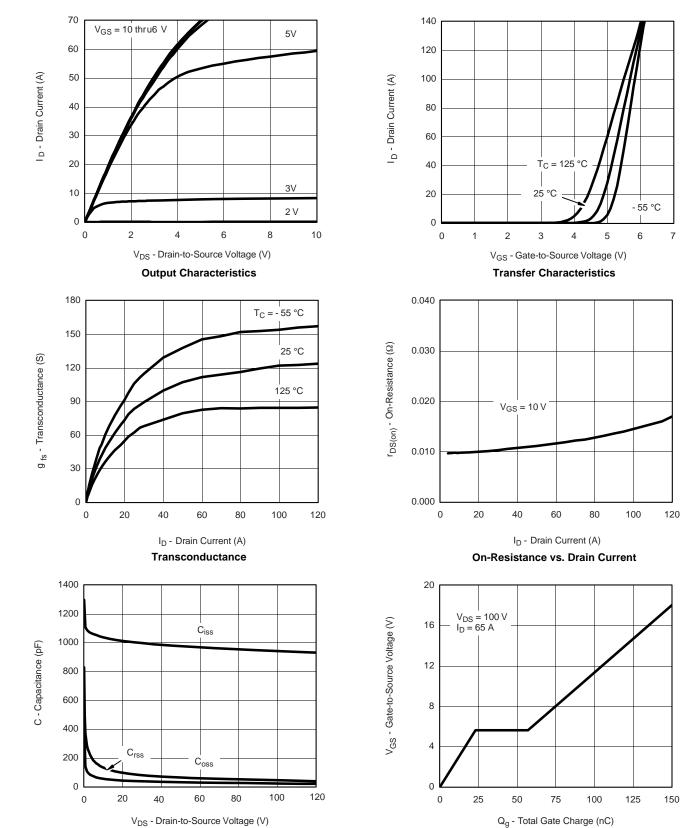
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

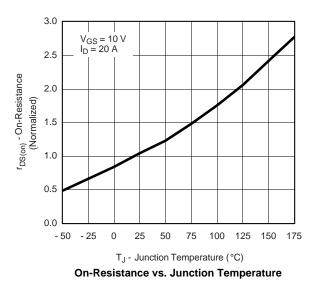
服务热线:400-655-8788

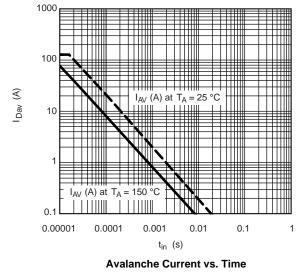
Capacitance

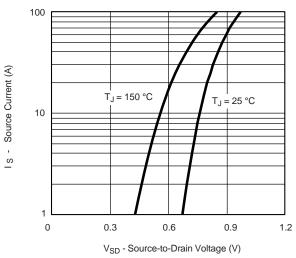
Gate Charge



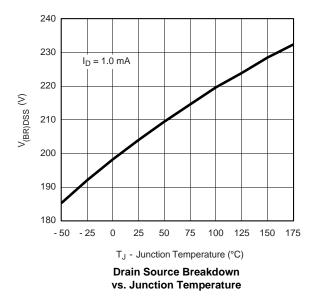
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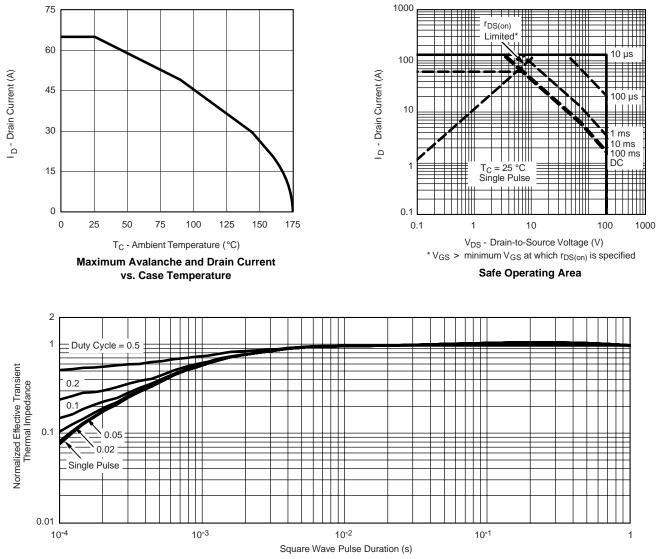
Source-Drain Diode Forward Voltage



IRL530STRR-VB



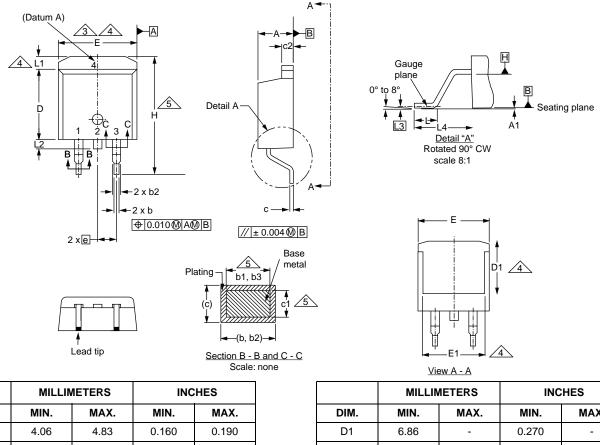
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)



		-						
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	IM. MIN.	MAX.	MIN.
А	4.06	4.83	0.160	0.190	D1	01 6.86	-	0.270
A1	0.00	0.25	0.000	0.010	E	E 9.65	10.67	0.380
b	0.51	0.99	0.020	0.039	E1	6.22	-	0.245
b1	0.51	0.89	0.020	0.035	е	e 2.54	BSC	0.100
b2	1.14	1.78	0.045	0.070	Н	H 14.61	15.88	0.575
b3	1.14	1.73	0.045	0.068	L	L 1.78	2.79	0.070
с	0.38	0.74	0.015	0.029	L1	_1 -	1.65	-
c1	0.38	0.58	0.015	0.023	L2	.2 -	1.78	-
c2	1.14	1.65	0.045	0.065	L3	.3 0.25	BSC	0.010
D	8.38	9.65	0.330	0.380	L4	4 4.78	5.28	0.188

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

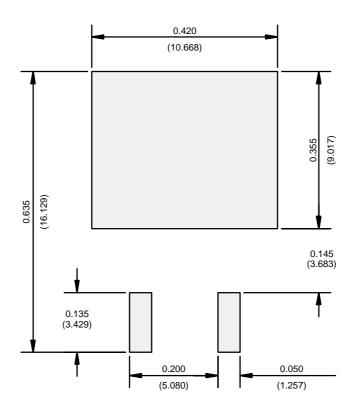
5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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